

Title (en)
LATEX, COMPOSITION FOR DIP MOLDING AND DIP MOLDED BODY

Title (de)
LATEX, ZUSAMMENSETZUNG FÜR EINE TAUCHFORMUNG UND TAUCHGEFORMTER KÖRPER

Title (fr)
LATEX, COMPOSITION POUR MOULAGE PAR IMMERSION ET CORPS MOULÉ PAR IMMERSION

Publication
EP 2799483 B1 20170823 (EN)

Application
EP 12863797 A 20121128

Priority
• JP 2011284803 A 20111227
• JP 2012080718 W 20121128

Abstract (en)
[origin: EP2799483A1] A latex of synthetic polyisoprene and/or a styrene-isoprene-styrene block copolymer with a weight average molecular weight of 10,000 to 5,000,000, a volume average particle size of 0.5 to 10 µm, and a content of a total of an alicyclic hydrocarbon solvent and aromatic hydrocarbon solvent of 500 weight ppm or less are provided.

IPC 8 full level
B29C 41/14 (2006.01); **C08J 3/07** (2006.01); **C08J 5/02** (2006.01); **C08L 9/10** (2006.01); **C08L 53/02** (2006.01); **B29K 9/00** (2006.01); **B29K 105/00** (2006.01); **B29K 296/04** (2006.01)

CPC (source: EP US)
B29C 41/14 (2013.01 - EP US); **C08J 3/07** (2013.01 - US); **C08J 5/02** (2013.01 - EP US); **C08L 9/10** (2013.01 - EP US); **C08L 53/02** (2013.01 - EP US); **B29K 2009/00** (2013.01 - EP US); **B29K 2105/0064** (2013.01 - EP US); **B29K 2296/04** (2013.01 - EP US); **C08J 2309/10** (2013.01 - EP US); **C08J 2347/00** (2013.01 - US); **C08J 2353/02** (2013.01 - EP US)

Cited by
EP3587462A4; EP3412708A4; EP3409719A4; EP3543261A4; EP3424984B1; WO2017150199A1

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)
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